

PATENT

3/21/02
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application : Kiyoto Takizawa, et al.
Application No. : 09/740, 513
Filed : December 19, 2000
For : INJECTION MOLDING MACHINE FOR LOW-MELTING
POINT METALLIC MATERIAL
Examiner : K. Kerns
Attorney's Docket : AK-339XX

Group Art Unit: 1725

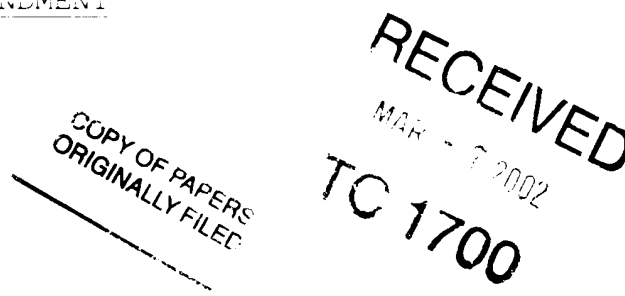
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231 on 3/22/02.

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AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:



In response to the Office Action dated September 24, 2001, please amend the above-identified patent application as follows. A marked-up version of the amendments is enclosed herewith for the Examiner's convenience.

In the Drawings

APPROVED
FOR FILING
[Signature]